

# P-CHANNEL ENHANCEMENT MODE MOSFET WITH INTEGRATED SBR<sup>®</sup> SUPER BARRIER RECTIFIER

#### **Features**

- Low On-Resistance
  - 95mΩ @V<sub>GS</sub> = -4.5V
  - 120mΩ @V<sub>GS</sub> = -2.5V
  - 86mΩ (typ) @V<sub>GS</sub> = -1.8V
  - Low Gate Threshold Voltage, -1.3V Max
- Fast Switching Speed
- Low Input/Output Leakage
- Incorporates Low V<sub>F</sub> Super Barrier Rectifier (SBR)
- Low Profile, 0.5mm Max Height
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

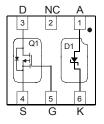
## Mechanical Data

- Case: U-DFN2020-6 Type B
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208 €
- Weight: 0.0065 grams (approximate)

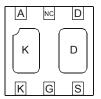
U-DFN2020-6

Type B

Bottom View



Top View Internal Schematic



Bottom View Pin Configuration

### Ordering Information (Note 4)

Part Number	Case	Packaging
DMS2220LFDB-7	U-DFN2020-6 Type B	3000/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and</li>

<1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

### Marking Information

Data Orda Ka

Notes:



ME = Marking Code YM = Date Code Marking Y = Year (ex: V = 2008) M = Month (ex: 9 = September) Dot denotes Pin 1

Date Code Key	-											
Year	2008	2009	20	10	2011	2012	2013	2014	20	15	2016	2017
Code	V	W	)	κ	Y	Z	Α	В	(	0	D	E
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings – TOTAL DEVICE (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1.4	W
Thermal Resistance, Junction to Ambient	R <sub>0JA</sub>	89	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	C°

# Maximum Ratings – P-CHANNEL MOSFET – Q1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Drain-Source Voltage	V <sub>DSS</sub>	-20	V
Gate-Source Voltage	V <sub>GSS</sub>	±12	V
Drain Current (Note 5)	ID	-3.5	А
Pulsed Drain Current (Note 6)	I <sub>DM</sub>	-12	А

## Maximum Ratings – SBR – D1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	14	V
Average Rectified Output Current	lo	1	А
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	3	A

# Electrical Characteristics – P-CHANNEL MOSFET – Q1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	<b>,</b>		- 71-			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20		—	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250µA
Zero Gate Voltage Drain Current	IDSS	—	_	-1	μA	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>			±100 ±800	nA	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$ $V_{GS} = \pm 12V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)			-			
Gate Threshold Voltage	V <sub>GS(th)</sub>	-0.45	_	-1.3	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
		_	60	95		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -2.8A
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	74	120	mΩ	V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -2.0A
		-	86	—		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -1.0A
Forward Transfer Admittance	Y <sub>fs</sub>	_	8		S	V <sub>DS</sub> = -5V, I <sub>D</sub> = -2.8A
Diode Forward Voltage (Note 7)	V <sub>SD</sub>	_	0.7	-1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = -1.6A
DYNAMIC CHARACTERISTICS						·
Input Capacitance	Ciss	—	632	_	pF	
Output Capacitance	C <sub>oss</sub>	—	65	_	pF	V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	54	_	pF	

### Electrical Characteristics – SBR – D1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V <sub>(BR)R</sub>	20			V	I <sub>R</sub> = 1mA
Forward Voltage	V <sub>F</sub>			0.45 0.52	V	I <sub>F</sub> = 0.5A I <sub>F</sub> = 1.0A
Reverse Current (Note 7)	I <sub>R</sub>			100	μA	V <sub>R</sub> = 20V

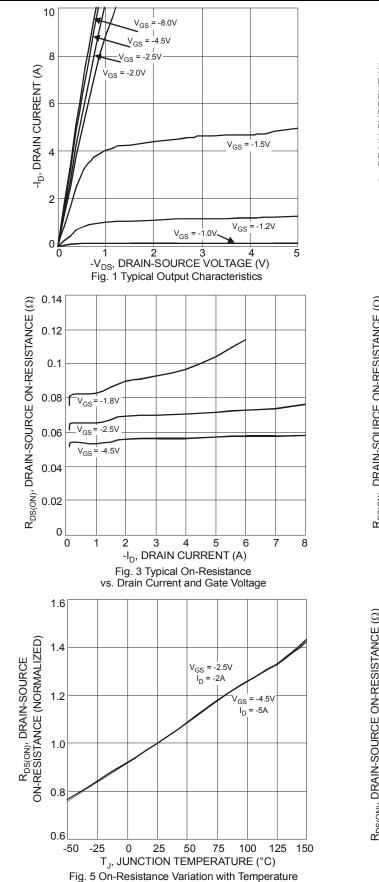
Notes: 5. Device mounted on FR-4 PCB, on minimum recommended, 2oz Copper pad layout.

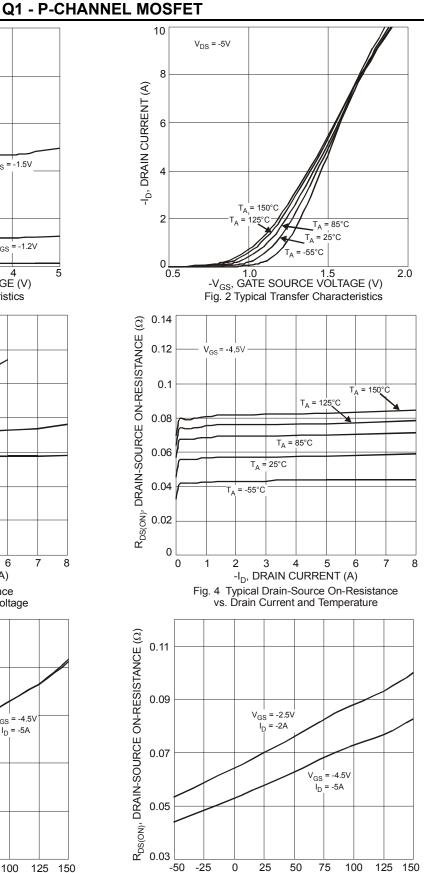
6. Repetitive rating, pulse width limited by junction temperature.

7. Short duration pulse test used to minimize self-heating effect.



# DMS2220LFDB



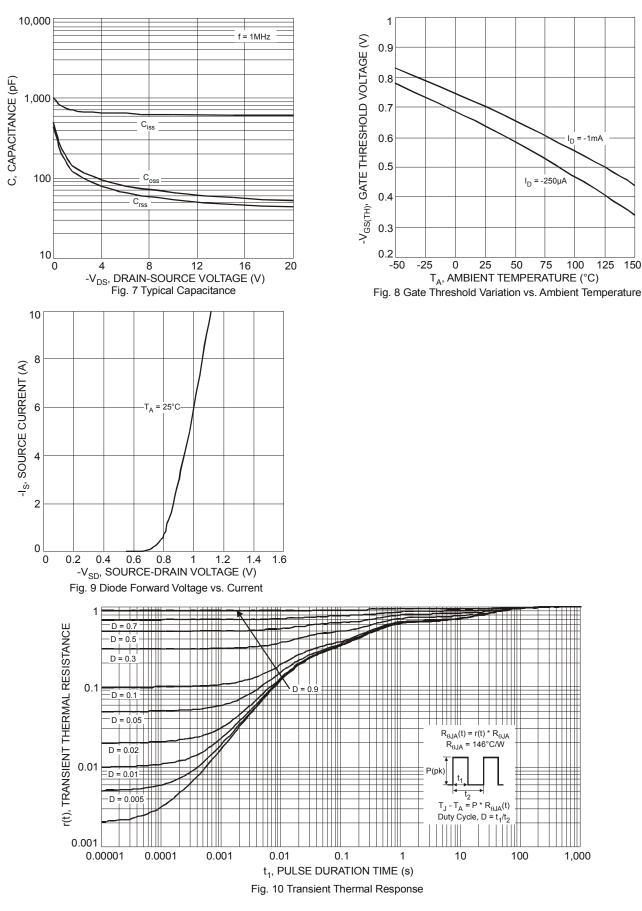


TJ, JUNCTION TEMPERATURE (°C)

Fig. 6 On-Resistance Variation with Temperature

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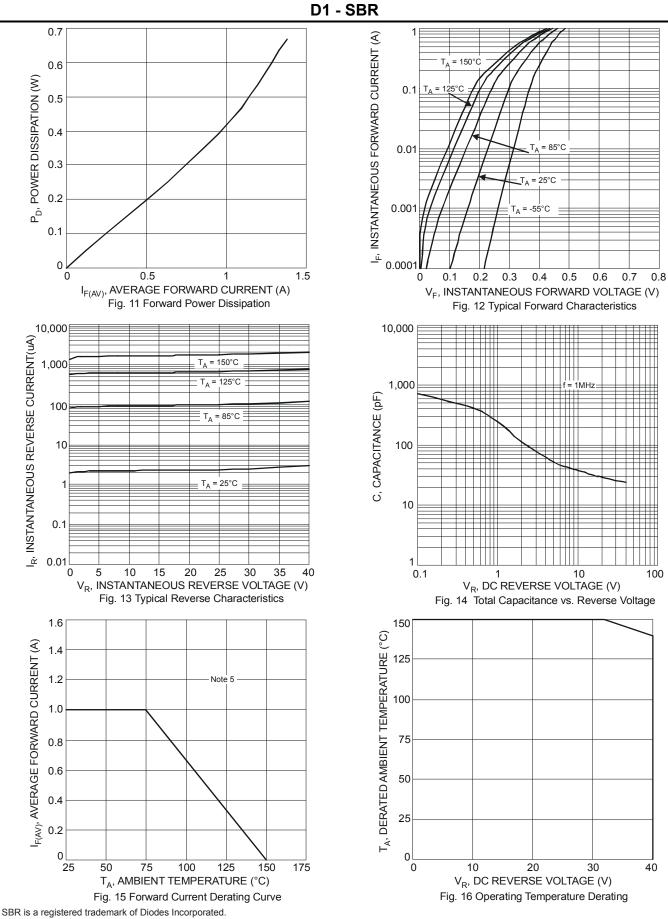




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# DMS2220LFDB



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Тур

0.575

0.02

0.13

0.25

2.00

0.45

0.60

0.65

2.00

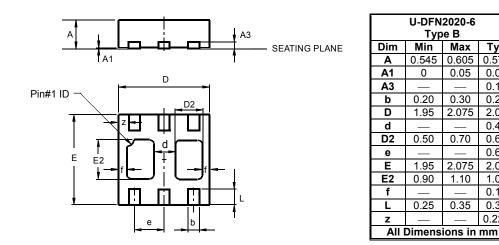
1.00

0.15

0.30 0.225

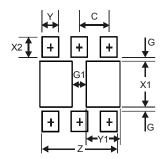
# **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



# Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	1.67
G	0.20
G1	0.40
X1	1.0
X2	0.45
Y	0.37
Y1	0.70
С	0.65

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